



12500 TI Boulevard, MS 8640, Dallas, Texas 75243

**PCN# 20121012004
ADD MSL3 OPTION TO PTH04T220WAD LABELING
Information Only**

Date: 10/17/2012
To: MOUSER PCN

Dear Customer:

This is an information-only announcement of a change to a device that is currently offered by Texas Instruments.

The changes discussed within this PCN are for your information only. Please see the attachment details for the planned implementation date.

This notification period is per TI's standard process. Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager (PCN_ww_admin_team@list.ti.com).

Sincerely,

PCN Team
SC Business Services
Phone: +1(214) 480-6037
Fax: +1(214) 480-6659

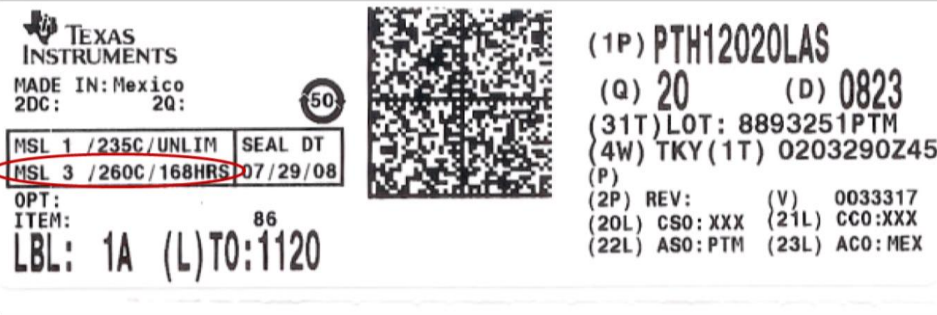
20121012004
Attachment: 1

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
PTH04T220WAD	null

Technical details of this Product Change follow on the next page(s).

PCN Number:	20121012004			PCN Date:	10/17/2012				
Title:	ADD MSL3 OPTION TO PTH04T220WAD LABELING								
Customer Contact:	PCN Manager	Phone:	+1(214) 480-6037	Dept:	Quality Services				
Change Type:									
<input type="checkbox"/> Assembly Site	<input type="checkbox"/> Assembly Process	<input type="checkbox"/> Assembly Materials							
<input type="checkbox"/> Design	<input type="checkbox"/> Electrical Specification	<input type="checkbox"/> Mechanical Specification							
<input type="checkbox"/> Test Site	<input checked="" type="checkbox"/> Packing/Shipping/Labeling	<input type="checkbox"/> Test Process							
<input type="checkbox"/> Wafer Bump Site	<input type="checkbox"/> Wafer Bump Material	<input type="checkbox"/> Wafer Bump Process							
<input type="checkbox"/> Wafer Fab Site	<input type="checkbox"/> Wafer Fab Materials	<input type="checkbox"/> Wafer Fab Process							
PCN Details									
Description of Change:									
<p>The bar code label for the PTH04T220WAD will be modified to include MSL conditions for soldering temperature profiles up to 260C. Currently, the label only has MSL conditions for soldering temperature profiles up to 235C.</p> <table border="1" style="margin: 10px auto; width: 60%;"> <thead> <tr> <th style="text-align: center;">Current MSL info on Label</th> <th style="text-align: center;">New MSL info on Label</th> </tr> </thead> <tbody> <tr> <td style="text-align: center;">MSL 1/235C/UNLIM</td> <td style="text-align: center;"> MSL 1/235C/UNLIM MSL 3/260C/168HRS </td> </tr> </tbody> </table> <div style="text-align: center; margin-top: 20px;">  </div>						Current MSL info on Label	New MSL info on Label	MSL 1/235C/UNLIM	MSL 1/235C/UNLIM MSL 3/260C/168HRS
Current MSL info on Label	New MSL info on Label								
MSL 1/235C/UNLIM	MSL 1/235C/UNLIM MSL 3/260C/168HRS								
Reason for Change:									
Provide a dual moisture rating of MSL 3 260C and MSL 1 235C to address assembly requiring 260C reflow temperature.									
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):									
None									
Changes to product identification resulting from this PCN:									
None									
Product Affected:									
PTH04T220WAD									

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com